

## Summary

Detail-oriented engineer with demonstrated expertise in design, fabrication, test, and modeling of MEMS, microfluidics, and thermal systems. Hands-on experience in device characterization (optical, structural, thermal, electrical). Skilled with CAD, CFD tools, and structural Finite Element Analysis

## Technical Skills and Experience

**General skills/prototyping:** Data acquisition, Rapid prototyping, Machine shop, Controllers/sensors

**Microfabrication:** Photomask Design, Photolithography, spin coating, dry oxidation, Wet/Dry Etch, Wafer Bonding, Wafer Packaging, Thin films, Oxygen plasma bonding

**Analytical Skills:** Microfluidics, MEMS Design, Thermal analysis, Statistical Process Control (SPC), FMEA, Finite Element Analysis (FEA), CAD tools, Data analysis, Fluid flow, Structural analysis

**Characterization:** SEM, 3D confocal laser microscope (VK-100), Optical microscope, Film thickness measurement (Filmetrics), Surface profilometer (Dektak 150), Infrared Thermography (FLIR), thermal sensors

## Software Skills

- ANSYS-Fluent
- L-Edit
- C/C++
- COMSOL
- SolidWorks
- Microsoft Office
- MATLAB
- AutoCAD
- R
- LabView
- TCAD
- Minitab

## Work Experience

### Postdoctoral Research Fellow

Aug 2019-present

Ruston, LA

*Multiscale Energy and Materials lab, Louisiana Tech University*

- Conducted validation tests, accurate thermal measurements, and data acquisition to evaluate the heat transfer performance of different thermal management solutions (multiphase, forced convection, natural convection)
- Improved the surface cooling performance by forming CuO nano-structures coating on heating surface
- Led the image processing project for extracting the bubble features (diameter, number) from high speed videos
- Collaborated in design, fabrication, and test of a setup for evaluating the multi-phase cooling at saturation point

### Graduate Research Assistant

Sep 2013-Feb 2019

Ruston, LA

*Microfluidics Lab, Louisiana Tech University*

- Designed a single complementary photomask for front and backside photolithography process (2 layer)
- Generated a hard mask for KOH etch process by HF etching of the SiO<sub>2</sub> layer grown through dry oxidation
- Applied photolithography (front and backside) and anisotropic etch (KOH etch of silicon) for defining microchannels in silicon wafer
- Performed wafer dicing, bonding, and packaging to seal the counterflow microfluidic devices
- Applied the low-cost rapid prototyping technique to fabricate the hybrid (Glass/Kapton/Quartz) microfluidic chips
- Performed GR&R analysis to find the uncertainty associated with the performance of microfluidic device

### Intern

June 2009-Sep 2009

Iran, Shiraz

*Farabard Co, Design, production, and construction of cooling towers for industry*

- Applied Meshing tool Gambit software for generating mesh for NACA airfoils
- Interpreted handbooks, designs, and industrial standards

## Technical Projects

- Design analysis of a highly sensitive thermoelectric MEMS sensor for biological sensing applications (FEA)
- Experimental and numerical study of pressure effect on natural convection cooling (CFD)
- Process simulation of a delta-doped MOSFET using TSUPREM4
- Nonlinear Mechanical-electrical analysis of a flexible 3D printed MEMS strain-sensor (FEA)

## Education

### Ph.D.

Feb. 2019

GPA 3.88

Engineering, Micro/Nanoscale Systems

Louisiana Tech University, Ruston, LA

Dissertation title: "Development of a Counter-flow Thermal Gradient Microfluidic Device"

### Master of Engineering

Jan. 2012

GPA 3.46

Mechanical Engineering Department

Sahand University of Technology, Tabriz, Iran

Thesis title: "Numerical analysis of flow and heat transfer of wavy microchannels in slip-flow regime" (Forced Convection cooling application)

### Bachelor of Science

Sep. 2009

GPA 3.00

Mechanical Engineering Department

Shiraz University, Shiraz, Iran

## PUBLICATIONS/ TECHNICAL PRESENTATIONS

**Shayan Davani**, Varun L. Koppa, Niel D. Crews. "Detecting Thermal Asymmetry in Microfluidics for Sensor Applications: Critical Design Considerations and Optimization" International Journal of Heat and Mass Transfer, 2019

**Shayan Davani**, Farnaz Rezaei, Arden L. Moore, Niel D. Crews. "Counter-flow for Stabilization of Microfluidic Thermal Reactors". Applied Thermal Engineering Journal, **Under Review**, October 2020

**Shayan Davani**, S. M. Mahdi Mofidian, Kasra Momeni, Hamzeh Bardaweel. "3D-Printed Strain Sensors: Electro-Mechanical Simulation and Design Analysis using Nonlinear Material Model and Experimental Investigation". IEEE sensors, 2020

**Shayan Davani**, Bin Zhang, Luke Hansen, Wen J. Meng, Arden, L. Moore. "Subcooled Pool Boiling Performance of As-rolled and Nanostructure-modified 1D Micro-Fin Arrays by High Throughput Roll Molding". **Working paper**

Brandon Doran, Bin Zhang, Kojo Asiamah Osafo, **Shayan Davani**, Abigail Walker, Stephen Akwabo, Wen J. Meng, Patrick Mensah, Arden L. Moore. "Subcooled Pool Boiling Performance of Aluminum Alloy 1D Micro-Fin Arrays Fabricated by High Throughput Roll Molding". **Working paper**

**Shayan Davani**, Bin Zhang, Luke Hansen, Wen Jin Meng, Arden, L. Moore. "Subcooled Pool Boiling Performance of As-rolled and Nanostructured 1D Micro-Fin Arrays by High Throughput Roll Molding". 2020 Consortium for Innovation in Manufacturing & Materials (CIMM) Symposium (LA EPSCoR)- **3<sup>rd</sup> place (Among the participants of five Louisiana Universities)**

**Shayan Davani**, Varun L. Koppa, Niel D. Crews. "Continuous-flow Microfluidic Calorimeter: Sensitivity Optimization of Experimental Prototype through 3-D Modeling." International Conference on Nanochannels, Microchannels, and Minichannels, ASME2017

**Shayan Davani**, Varun L. Koppa, Niel D. Crews. "Highly Sensitive Thermal Sensor for Microfluidic Chips: 3-D Modeling for Design Considerations and Optimizations". International Conference on Nanochannels, Microchannels, and Minichannels, ASME2017

**Shayan Davani**, Niel D. Crews. "Characterization and Modification of a Mesoscale Temperature Gradient". Heat Transfer, Fluids Engineering, & Nanochannels, Microchannels, and Minichannels Conferences, ASME 2016

## Certifications/ Organizations

**SIX-SIGMA (GREEN BELT)**

**MATLAB Image processing**

**Learning LabView**

**Introduction to GD&T**

Louisiana Tech University

UDEMY

LinkedIn Learning

LinkedIn Learning

Apr 2017-No expiration date

Dec 2019-No expiration date

Nov 2020-No expiration date

Nov 2020-No expiration date

**Organizations** ASME (2015-present), SAMPE (2018, present)